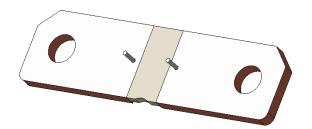


VSPA6918SY-0M10J, Shunt Sensor (Lead / Halogen Free)

Features / Applications :

- High power rating is up to 36W
- Low inductance (< 5 nH)
- Low thermal EMF (< $3 \mu V/^{\circ}C$)
- Welding construction; Excellent long-term stability
- RoHS compliant & AEC-Q200 qualified
- Automotive applications & Current sensing for BMS
- Sn plating assists with PCB mounting and corrosion protection



Electrical Specifications:

Characteristics	Feature
Power Rating*	36 W
Resistance Value	100 μΩ
Temperature Coefficient of Resistance	± 100 ppm/°C
Operation Temperature Range	-65°C~ +170°C
Resistance Tolerance	± 5% (J)
Maximum Working Voltage (V)	(P*R) ^{1/2}

^{*}Note:

For sensors operated at terminal temperature in excess of 140°C, the maximum load shall be derated in accordance with the following curve.

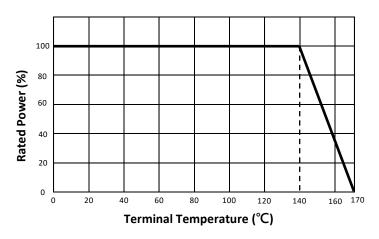


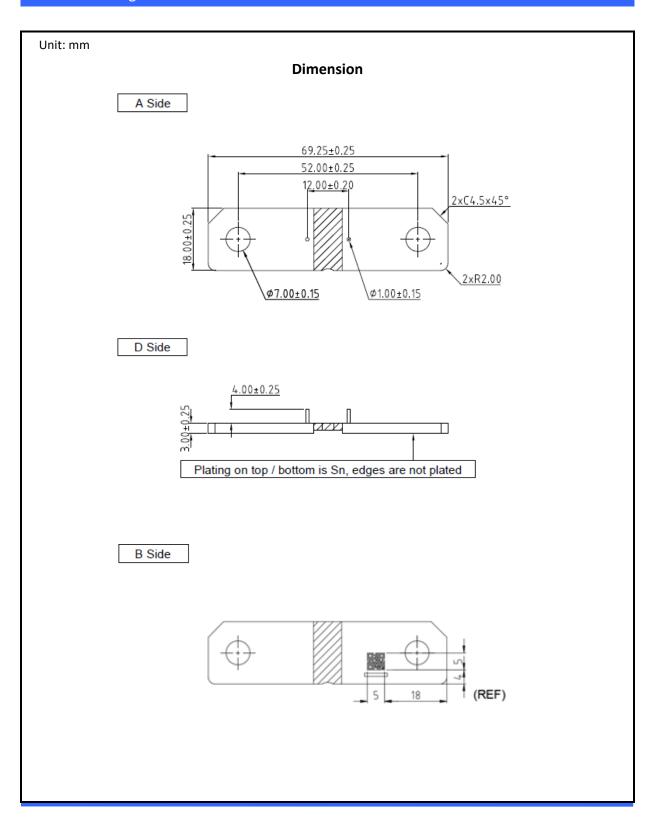
Figure 1. : Power derating curve at terminal temperature

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Outline Drawing:



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Type Designation :

VSPA 6918 S Y - 0M10 J

(1) (2) (3) (4) - (5) (6)

Note:

(1) Series No.

(2) Size

(3) Terminal type : S = Short terminal

(4) Power Rating: Y = 36W

(5) Resistance value : 0M10 = 100 $\mu\Omega$

(6) Tolerance: $J = \pm 5\%$

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Characteristics:

Electrical

Item	Specification and Requirement	Test Method
Temperature Coefficient (TCR)	As follow specification	JIS-C-5201 +25°C/ +125°C.
Short Time Overload	\triangle R: \pm 0.5% Without damage by flashover, spark, arcing, burning or breakdown	JIS-C-5201-1 4.13 5 x rated power for 5 seconds.
ESD	△R: ± 1%	AEC-Q200-002 Human body, 8KV.

Mechanical

Item	Specification and Requirement	Test Method
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	J-STD-002 $245 \pm 5^{\circ}\text{C} \text{ for } 5 \pm 0.5 \text{ seconds.}$
Resistance to Solder Heat	△R: ± 0.5%	MIL-STD-202 Method 210 $260 \pm 5^{\circ}\text{C} \ \text{ for } 10 \pm 1 \text{ seconds}.$
Vibration	\triangle R: \pm 0.5% Without distinct damage in appearance	MIL-STD-202 Method 204 5G's for 20 minutes, 12 cycles each of 3 orientations. Test from 10-2000Hz.
Mechanical Shock	\triangle R: \pm 0.5% Without distinct damage in appearance	MIL-STD-202 Method 213 100G's peak value, 6ms, Half-sine waveform, 12.3ft/sec.
Pin Strength	Without damage and break from bottom of pin.	Test height <1.6mm from bottom of pin.

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Endurance

Item	Specification and Requirement	Test Method
Temperature Cycling	△R: ± 0.5%	JESD22 Method JA-104 1000 cycles, (-55°C~150°C) 30 min maximum dwell time at each temperature.
Biased Humidity	△R: ± 0.5%	MIL-STD-202 Method 103 1000 hours, 85°C/85%R.H, applied for 10% rated power.
Operational Life	△R: ± 1.0%	MIL-STD-202 Method 108 100% Rate power for 1,000 hours at terminal temperature 140°C.
High Temperature Store	△R: ± 1.0%	MIL-STD-202 Method 108 170°C for 1,000 hours.

Note : Measurement at 24 \pm 4 hours after test conclusion for all reliability tests-parts.

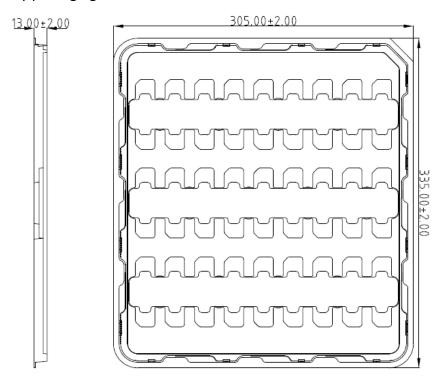
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Packaging:

Tray packaging dimensions:



Label Marking:

The following items shall be marked on tray

- (1) Description
- (2) Quantity
- (3) Part No.
- (4) Tapping No.

Quantity: 27 Pcs / Tray

135 Pcs / Carton

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Care Note:

Care note for storage

- (1) Shunt sensor shall be stored in a environment where temperature and humidity must be controlled (temperature 5 to 35° C, humidity < 60% RH). However, the humidity should be maintained as low as possible.
- (2) Shunt sensor shall not be stored under direct sunlight.
- (3) Shunt sensor shall be stored in condition without moisture, dust, any material defect solderability, or hazardous gas (i.e. Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen)
- (4) The sensor can be stored for at least one year under the condition mentioned above.

Care note for operating and handling

- (1) Protect the edge and coating of the sensors from mechanical stress.
- (2) Avoid bending of printing circuit board (PCB) when cutting and fixing it on support body to reduce mechanical stress on sensors.
- (3) Sensor should be used within the condition of specification.
 Note: When a voltage higher than specified value is loaded to the sensor, this may damage the sensor material due to temperature rise.
- (4) The loaded voltage should consult terminal temperature of the sensor according to the derating curve.
- (5) When applying a high current exceeding suggested specification (pulse current, shock current) to the sensor, it is necessary to re-evaluate the operating condition before using it in the system.

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